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	n Mezzanine IEEE 1386 Receptacle, Surface Mount, Dual Row, nbossed Tape on Reel, 0.76μm (30μ") Gold (Au), 64 Circuits Pick				
Documents: 3D Model Drawing (PDF)	Product Specification PS-71436-9999 (PDF) RoHS Certificate of Compliance (PDF)	Serie			
Agency Certification		image - Reference only			
CSA	LR19980				
UL	E29179	EU RoHS China RoHS			
52	220110	ELV and RoHS			
General		Compliant			
Product Family	PCB Receptacles	REACH SVHC			
Series	71439	Contains SVHC: No			
Application	Board-to-Board	Halogen-Free			
Comments	Plugs	Status			
Product Name	Mezzanine	Halogen-Free			
i loddot Name	Wollanno	Need more information on product			
Physical		environmental compliance?			
Circuits (Loaded)	64	environmental compliance:			
Color - Resin	Natural	Email productcompliance@molex.com			
Flammability	94V-0	For a multiple part number RoHS Certificate of			
Glow-Wire Compliant	No	Compliance, click here			
Lock to Mating Part	Yes				
Mated Height (in)	0.315 ln, 0.354 ln, 0.394 ln	Please visit the Contact Us section for any			
Mated Height (mm)	10.00 mm, 8.00 mm, 9.00 mm	non-product compliance questions.			
Material - Metal	Phosphor Bronze				
	Gold				
Material - Plating Mating					
Material - Plating Termination Material - Resin	Tin Llick Temperature Thermonlastic	Search Parts in this Series			
	High Temperature Thermoplastic 2	71439Series			
Number of Rows	_				
Orientation	Vertical	Martan Mitch			
PCB Locator	Yes	Mates With			
PCB Retention	None	<u>714360</u> for Stack Height 8.00mm (.315"),			
Packaging Type	Embossed Tape on Reel	714361 for Stack Height 9.00mm (.354"),			
Pitch - Mating Interface (in)	0.039 In	714362 for Stack Height 10.00mm (.394")			
Pitch - Mating Interface (mm)	1.00 mm				
Plating min: Mating (µin)	30.4				
Plating min: Mating (µm)	0.76				
Plating min: Termination (µin)	76.4				
Plating min: Termination (µm)	1.91				
Polarized to PCB	No				
Robotic Placement	Pick and Place Cap				
Surface Mount Compatible (SMC)	N/A				
Temperature Range - Operating	-55°C to +85°C				
Termination Interface: Style	Surface Mount				
Electrical					
	4.6				
Current - Maximum per Contact	1A 100/				
Voltage - Maximum	100V				
Solder Process Data					
Duration at Max. Process Temperature (sec	onds) 40				
Lood free Dreeses Conshility	Unus) 40 Defleux Ceneble (CMT enhi)				

Reflow Capable (SMT only)

Lead-free Process Capability

Max. Cycles at Max. Process Temperature Process Temperature max. C

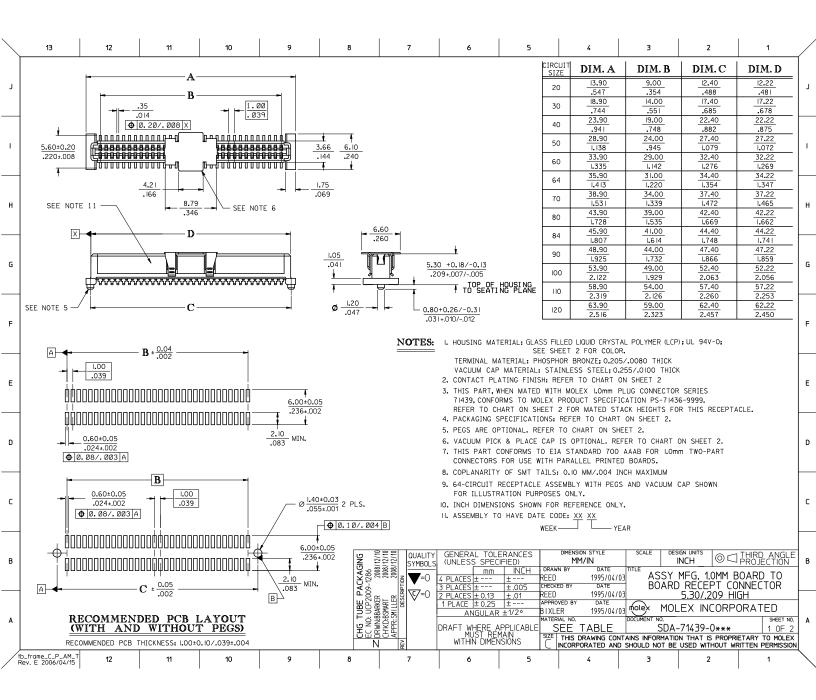
Material Info

Reference - Drawing Numbers Product Specification Sales Drawing

PS-71436-9999, RPS-71436-002, RPS-71436-003 SDA-71439-0***

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					WHITE (NATUR.	AL)	MATERI	IAL				
			PART NUMBER	CIRCUIT SIZE	CONTACT PLA SEE NOTE BELOW	TING CHARTS PE	egs P	VICK & PLACE CAP	PACKAGING SPEC. NUMBER	PACKAGING TYPE]		
			7 1439-0 164	64	30 GOLD	YI	res	NO	PK-70873-013	TUBE			
			71439-0264	64	50 GOLD	N	NO	YES	PK-70873-063	TAPE & REEL			
			71439-0364	64	30 GOLD	YE	ES	YES	PK-70873-014	TUBE	1		
			71439-0464	64	30 GOLD	YE	'ES	YES	PK-70873-063	TAPE & REEL			
			7 439-0564	64	30 GOLD	N	NO	NO	PK-70873-015	TUBE			
			71439-0764	64	30 GOLD	N	10	YES	PK-70873-017	TUBE			
			71439-0864	64	30 GOLD	N	NO	YES	PK-70873-063	TAPE & REEL	1		
			71439-0664	64	50 GOLD	YI	(ES	NO	PK-70873-013	TUBE			
			71439-0064	64	50 GOLD	N	NO	NO	PK-70873-015	TUBE]		
					B	BLACK N	MAI	FERIAL		1	7		
			PART NUMBER	CIRCUIT SIZE	CONTACT PLA SEE NOTE BELOW	TING CHARTS PE	egs P	VICK & PLACE CAP	PACKAGING SPEC. NUMBER	PACKAGING TYPE			
			71439-0964	64	30 GOLD	N	NO	YES	PK-70873-063	TAPE & REEL	=		
											1		
							C	ONTACT PLATI 30 GOLD -		R/30 MICROINCH N	MINIMUM GOLD	IN CONTACT AR	EA AND
			PLUG STACK	HEIGHT					1.91 MICROMETER/	75 MICROINCH MI EL UNDERPLATE O	NIMUM TIN IN	SOLDER	
		IT BOARD DNNECTOR	PLUG STACK HEIGHT + RECEPTACLE STACK HEIGHT + 0.407.016 (SOLDER PASTE ALLOWANCE) 50 GOLD - 1.27 MICROMETER/50 MICROINCH MINIMUM GID IN CONTACT AR 1.91 MICROMETER/75 MICROINCH MINIMUM TIN IN SOLDER							SOLDER	A AND		
	Yamamin	= MATED STACK HEIGHT TAIL AREA. NICKEL UNDERPLATE OVER ENTIRE TERMINAL.											
RECOMMENDED PLOGRECEPTALE COMBINATION FOR MATED STACK HEIGHT PER EIA STANDARD 700 AAAB													
	н́ М	R R			MATED S HEIGH		RECEPTACLE HEIGHT	RECEPTACLE SERIES NO.	PLUG HEIGHT	LUG SERIES NO.			
			P = PLUG STA	8.00/.3		5.30/.209 5.30/.209	71439-0***		7 436-0*** 7 436- ***				
		CLE CONNECTOR	R = RECEPTACI H = MATED ST	LE STACK H	EIGHT	10.00/.3		5.30/.209	7 439-0***		7 436-2***		
											SCALE DE	INCH	J THIRD ANGL
					KAGIN 286 2008/1	SYMB	0000	UNLESS SPE		MM/IN N BY DATE 1995/04/0		MFG, 1.0MM	BOARD TO
					PAC 2009-1		- 1	PLACES ± PLACES ± 0.13	±.005 CHECKE ±.01 REED	ер ву — рате 1995/04/0	d boar	D RECEPT C 5.30/.209 H	
					LUBE	SMILLE		PLACE ± 0.25 ANGULA	± APPRO R ±1/2° BIXLE			LEX INCORF	PORATED
					1 9 3	التنقة			MATERI		DOCUMENT NO.		SHEET I
							DF	RAFT WHERE MUST RE WITHIN DIME	APPLICABLE SIZE	EE TABLE		-71439-0***	2 OF